

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Beilin et al.
Serial No.: Unassigned
Filed: Herewith
For: METHODS OF PLANARIZING
STRUCTURES ON WAFERS
AND SUBSTRATES BY POLISHING
Examiner: S. Ahmed
Group Art Unit: 1746
Attorney Docket: 25916-111 (53755)

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June 12, 2001

By

Jordan Wilson
Jordan Wilson

PRELIMINARY AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Please enter the following Preliminary Amendment to the accompanying patent application:

In The Specification:

On page 1, line 3, before 'FIELD OF THE INVENTION', insert the following paragraph:

A¹ This application is a continuation application of copending applications having Serial No. 09/259,125, filed February 26, 1999. Application Serial No. 09/259,125 is a continuation application of application having Serial No. 08/717,266, filed on September 20, 1996. Benefit of all earlier filing dates is claimed.